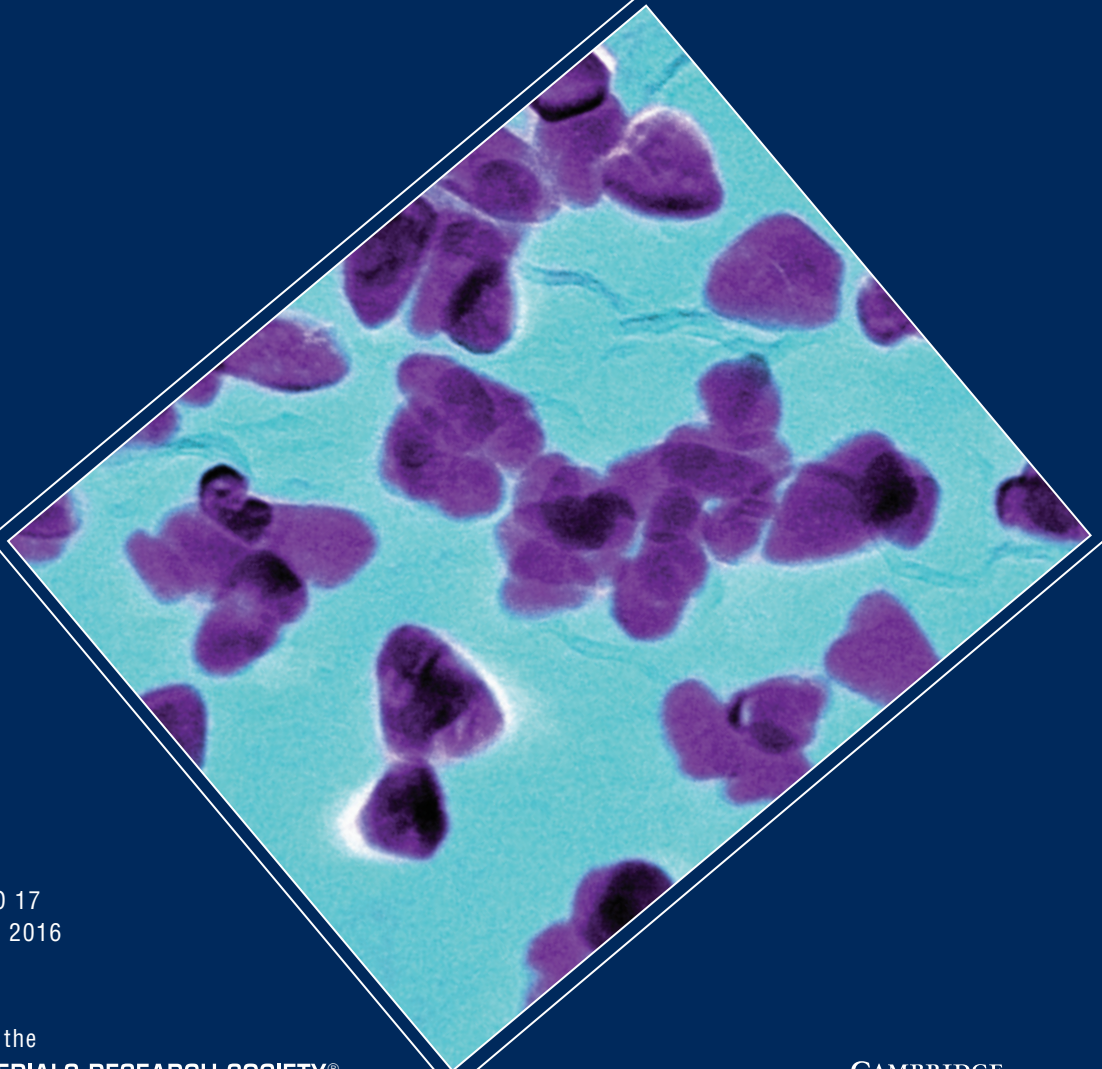




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Cover: Microscopical investigation of NPs. TEM (Transmission Electron Microscopy) micrographs of ZnO NPs dispersed in polymer solution that is later transformed to DLC (diamond-like carbon). [S. Buchegger, C. Vogel, R. Herrmann, B. Stritzker, A. Wixforth, C. Westerhausen: Antibacterial metal ion release from diamond-like carbon modified surfaces for novel multifunctional implant materials. p. 2571].

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